

# **Film Capacitors**

# Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32672L9 Date: November 2011

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#### Metallized Polypropylene Film Capacitors (MKP)

#### High V AC, high temperature (wound)

#### **Typical applications**

- Electronic ballasts (resonant circuits)
- SMPS
- High-frequency AC loads
- Pulse circuits

#### Climatic

- Max. operating temperature: +125 °C
- Climatic category (IEC 60068-1): 55/110/56

#### Construction

- Dielectric: polypropylene (PP)
- Wound capacitor technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing

#### Features

- Very high AC voltages for all frequency ranges
- Very small dimensions
- High peak voltage for short time periods
- High peak current
- High pulse withstand capability

#### Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

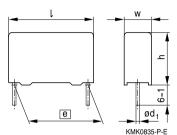
#### Marking

- Manufacturer's logo
- Lot number, series number
- Rated capacitance (coded)
- Capacitance Tolerance (code letter)
- Rated AC voltage
- Date of manufacture (coded)

#### **Delivery mode**

Bulk (untaped)

#### **Dimensional drawing**



Dimensions in mm

Lead spacing e ±0.4	Lead diameter d <sub>1</sub>
15	0.8

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### Overview of available types

Lead spacing	15 mm
Туре	B32672L9
Page	4
V <sub>RMS</sub> (V AC)	900
V <sub>R</sub> (V DC)	2000
C <sub>R</sub> (nF)	
0.68	
1.0	
1.5	
2.2	
3.3	
4.7	
5.6	
6.8	





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### Ordering codes and packing units

V <sub>RMS</sub>	V <sub>R</sub>	C <sub>R</sub>	Max. dimensions	Ordering code	Ammo	Reel	Untaped
f ≤1 kHz			$w \times h \times I$	(composition see	pack	pcs./	pcs./
V AC	V DC	nF	mm	below)	pcs./MOQ	MOQ	MOQ
900	2000	0.68	$5.0 \times 10.5 \times 18.0$	B32672L9681+***	4680	5200	4000
		1.0	$5.0\times10.5\times18.0$	B32672L9102+***	4680	5200	4000
		1.5	$6.0 \times 11.0 \times 18.0$	B32672L9152+***	3840	4400	4000
		2.2	$7.0 \times 12.5 \times 18.0$	B32672L9222+***	3320	3600	4000
		3.3	$8.5 \times 14.5 \times 18.0$	B32672L9332+***	2720	2800	2000
		4.7	$9.0 \times 17.5 \times 18.0$	B32672L9472+***	2560	2800	2000
		5.6	$11.0\times18.5\times18.0$	B32672L9562+***	-	2200	1000
		6.8	$11.0\times18.5\times18.0$	B32672L9682+***	-	2200	1000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series, intermediate capacitance values and closer tolerances on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

K = ±10% J = ±5% \*\*\* = Packaging code:

289 = Ammo pack

- 189 = Reel
- 000 = Untaped (lead length 6 -1 mm)



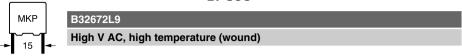
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#### **Technical data**

	1				
Operating temperature range	Max. operati	ng temp	erature T <sub>op,max</sub>	+125 °C	
	Upper category temperature T <sub>max</sub>			+110 °C	
	Lower category temperature T <sub>min</sub>			−55 °C	
	Rated temperature T <sub>R</sub>		+85 °C		
Dissipation factor tan $\delta$ (in 10 <sup>-3</sup> )	at	≤27 nF	27 nF< C <sub>R</sub> ≤0.1 μF	0.1 μF < C <sub>R</sub> ≤1 μF	>1 μF
at 20 °C	1 kHz	0.8	0.8	0.8	0.8
(upper limit values)	10 kHz	1.0	1.0	1.0	_
	100 kHz	2.0	3.0	-	_
Insulation resistance R <sub>ins</sub>	> 100 GΩ			•	
at 20 °C, rel. humidity $\leq$ 65%					
(minimum as-delivered values)					
DC test voltage	$1.6 \cdot V_R$ , 2 s				
Category voltage $V_{c}$	T <sub>A</sub> (°C)	DC vol	tage derating	AC voltage deration	ng
(continuous operation with $V_{\mbox{\tiny DC}}$	$T_A \le 85$	$V_{\rm C} = V_{\rm F}$	3	$V_{C,RMS} = V_{RMS}$	
or $V_{AC}$ at f $\leq$ 1 kHz)	85 <t<sub>A≤110</t<sub>	$V_{\rm C} = V_{\rm F}$	<sub>з</sub> · (165–Т <sub>А</sub> )/80	$V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$	
Operating voltage V <sub>op</sub> for	T <sub>A</sub> (°C)	DC vol	tage (max. hours)	AC voltage (max. hours)	
short operating periods	$T_A \le 100$	$V_{op} = 1$	.25 · V <sub>c</sub> (2000 h)	$V_{op} = 1.0 \cdot V_{C,RMS} (2000 \text{ h})$	
( $V_{DC}$ or $V_{AC}$ at f $\leq$ 1 kHz)	100 <t<sub>A≤125</t<sub>	$V_{op} = 1$	.25 · V <sub>c</sub> (1000 h)	$V_{op} = 1.0 \cdot V_{C,RMS} (1000 \text{ h})$	
Damp heat test	56 days/40 °	C/93% I	relative humidity	•	
Limit values after damp	Capacitance	change	e  ∆C/C	≤2%	
heat test	Dissipation f	actor ch	ange $\Delta$ tan $\delta$	$\leq 1.0 \cdot 10^{-3}$ (at 1 k	(Hz)
	Insulation re	sistance	R <sub>ins</sub>	≥ 50 GΩ	
Endurance test conditions	+85 °C / 250	0 V DC	/ 2000 h		
	+85 °C / 112	5 V AC	/ 2000 h		
	+110 °C / 17	20 V D0	C / 2000 h		
	+110 °C / 77	5 V AC	/ 2000 h		
Reliability:					
Failure rate $\lambda$	1 fit (≤ 1 · 10	) <sup>-9</sup> /h) at (	0.5 · V <sub>R</sub> , 40 °C		
Service life t <sub>SL</sub>	200 000 h at	1.0 · V	<sub>в</sub> , 85 °С		
	For conversi	on to otl	her operating condit	ions and temperate	ures,
	refer to chapter "Quality, 2 Reliability".				
Failure criteria:					
Total failure	Short circuit	•			
Failure due to variation	Capacitance	•		> 10%	
of parameters	Dissipation factor tan $\delta$ > 4 $\cdot$ upper limit value			alues	
	Insulation rea	sistance	e R <sub>ins</sub>	< 1500 MΩ	





#### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in  $V/\mu s$ .

" $k_0$ " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V<sup>2</sup>/µs.

Note:

The values of dV/dt and  $k_0$  provided below must not be exceeded in order to avoid damaging the capacitor.

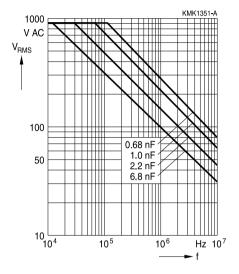
#### dV/dt and k<sub>0</sub> values

Lead spacing	15 mm	
Туре	B32672L9	
V <sub>RMS</sub> (V AC)	900	
V <sub>R</sub> (V DC)	2000	
C <sub>R</sub> (nF)	dV/dt in V/µs	k₀ in V²/μs
0.68	15000	3000000
1.0	15000	3000000
1.5	13500	2800000
2.2	11000	27500000
3.3	10000	2700000
4.7	8200	23500000
5.6	7500	19500000
6.8	6700	18400000

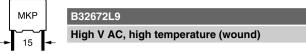


Permissible AC voltage  $V_{\text{RMS}}$  versus frequency f (for sinusoidal waveforms  $T_{\text{A}}$   ${\leq}100~^{\circ}\text{C}$ )

For  $T_A$  >100 °C, please refer to "General technical information", section 3.2.3.







#### **Mounting guidelines**

#### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder $\geq$ 90%, free-flowing solder

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s
МКР МКТ	(lead spacing $\leq$ 7.5 mm) uncoated (lead spacing $\leq$ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing $\leq$ 10 mm) and insulated (B32559)

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	В32672L9 МКР
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300 °C 260 °C, 4	KMK1242-V
250	
200	
150	
100	
50	
0 0 50 100 150	 200 s 250 ──► t
Immersion depth	2.0 +0/ $-0.5$ mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 $\pm$ 0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
tan δ	As specified in sectional specification





#### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### **Uncoated capacitors**

For uncoated MKT capacitors with lead spacings  $\leq$ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



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High V AC, high temperature (wound)

#### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





High V AC, high temperature (wound)

Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



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### Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α <sub>c</sub>	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β <sub>c</sub>	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C <sub>R</sub>	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
12	AC voltage due to current limit	Reduzierung der zulässigen
		Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
FD	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur
5		Diffusion
F <sub>T</sub>	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I <sub>c</sub>	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
	current)	, ,





High V AC, high temperature (wound)

Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i <sub>z</sub>	Capacitance drift	Inkonstanz der Kapazität
k <sub>0</sub>	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{\text{test}}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P <sub>diss</sub>	Dissipated power	Abgegebene Verlustleistung
P <sub>gen</sub>	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
Ri	Internal resistance	Innenwiderstand
R <sub>ins</sub>	Insulation resistance	Isolationswiderstand
R <sub>P</sub>	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$\tan \delta_{D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ <sub>P</sub>	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ <sub>s</sub>	Series component of dissipation factor	Serienanteil des Verlustfaktors
T <sub>A</sub>	Ambient temperature	Umgebungstemperatur
T <sub>max</sub>	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
t <sub>oL</sub>	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T <sub>op</sub>	Operating temperature	Beriebstemperatur
T <sub>R</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer
V <sub>AC</sub>	AC voltage	Wechselspannung



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## High V AC, high temperature (wound)

Symbol	English	German
Vc	Category voltage	Kategoriespannung
V <sub>C,RMS</sub>	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
V <sub>DC</sub>	DC voltage	Gleichspannung
$V_{\text{FB}}$	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V <sub>op</sub>	Operating voltage	Betriebsspannung
V <sub>p</sub>	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
V <sub>R</sub>	Rated voltage	Nennspannung
ν <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{\text{RMS}}$	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V <sub>sc</sub>	S-correction voltage	Spannung bei Anwendung "S-correction"
V <sub>sn</sub>	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß

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